

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6790174

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	ZHIBIN WU	12/17/2019
	HONG CHENG	12/19/2019
	SUDHIR KUMAR BAGHEL	12/19/2019
	SHAILESH PATIL	01/07/2020
	KAPIL GULATI	12/19/2019
	AJUN BHARADWAJ	12/23/2019
	TIEN VIET NGUYEN	12/19/2019
	SHUANSHUAN WU	12/18/2019
RECEIVING PARTY DATA		
Name:	QUALCOMM INCORPORATED	
Street Address:	5775 MOREHOUSE DRIVE	
City:	SAN DIEGO	
State/Country:	CALIFORNIA	
Postal Code:	92121-1714	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	17363251
CORRESPONDENCE DATA		
Fax Number:	(303)473-2720	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	303-473-2700	
Email:	dlwilliams@hollandhart.com	
Correspondent Name:	HOLLAND & HART LLP/QUALCOMM	
Address Line 1:	P.O. BOX 11583	
Address Line 4:	SALT LAKE CITY, UTAH 84147	
ATTORNEY DOCKET NUMBER:	PR164.01.01 (103038.2822)	
NAME OF SUBMITTER:	PAUL M. SCHRAMM	
SIGNATURE:	/PAUL M. SCHRAMM/	

DATE SIGNED:	06/30/2021
Total Attachments: 12 source=PR164.01.01 ASSIGN#page1.tif source=PR164.01.01 ASSIGN#page2.tif source=PR164.01.01 ASSIGN#page3.tif source=PR164.01.01 ASSIGN#page4.tif source=PR164.01.01 ASSIGN#page5.tif source=PR164.01.01 ASSIGN#page6.tif source=PR164.01.01 ASSIGN#page7.tif source=PR164.01.01 ASSIGN#page8.tif source=PR164.01.01 ASSIGN#page9.tif source=PR164.01.01 ASSIGN#page10.tif source=PR164.01.01 ASSIGN#page11.tif source=PR164.01.01 ASSIGN#page12.tif	

ASSIGNMENT

WHEREAS, WE,

1. Zhibin WU, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
2. Hong CHENG, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
3. Sudhir Kumar BAGHEL, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
4. Shailesh PATIL, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
5. Kapil GULATI, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
6. Arjun BHARADWAJ, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
7. Tien Viet NGUYEN, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,
8. Shuanshuan WU, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **UNICAST SIDELINK ESTABLISHMENT** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that

may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No. 16/665,555 filed October 28, 2019, Qualcomm Reference No. 190253, and all provisional applications relating thereto, together with U.S. Provisional Application No. 62/755,292 filed November 2, 2018, Qualcomm Reference No. 190253P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at 105 Altos, CA, on 12/17/19
CITY, STATE DATE


Zhibin WU

Done at _____, on _____
CITY, STATE DATE

Hong CHENG

Done at _____, on _____
CITY, STATE DATE

Sudhir Kumar BAGHEL

Done at _____, on _____
CITY, STATE DATE

Shailesh PATIL

Done at _____, on _____
CITY, STATE DATE

Kapil GULATI

Done at _____, on _____
CITY, STATE DATE

Arjun BHARADWAJ

Done at _____, on _____
CITY, STATE DATE

Tien Viet NGUYEN

Done at _____, on _____
CITY, STATE DATE

Shuanshuan WU

ASSIGNMENT

WHEREAS, WE,

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8. Shuanshuan WU, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **UNICAST SIDELINK ESTABLISHMENT** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that

may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No. 16/665,555 filed October 28, 2019, Qualcomm Reference No. 190253, and all provisional applications relating thereto, together with U.S. Provisional Application No. 62/755,292 filed November 2, 2018, Qualcomm Reference No. 190253P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
CITY, STATE DATE

Zhibin WU

Done at Bridgewater^{NJ}, on 12-19-2019
CITY, STATE DATE

Hong CHENG

Done at Bridgewater^{NJ}, on 12-19-2019
CITY, STATE DATE

Sudhir Kumar BAGHEL

Done at _____, on _____
CITY, STATE DATE

Shailesh PATIL

Done at Bridgewater^{NJ}, on 12-19-2019
CITY, STATE DATE

Kapil GULATI

Done at _____, on _____
CITY, STATE DATE

Arjun BHARADWAJ

Done at Bridgewater^{NJ}, on 12-19-2019
CITY, STATE DATE

Tien Viet NGUYEN

Done at _____, on _____
CITY, STATE DATE

Shuanshuan WU

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Done at _____, on _____
CITY, STATE DATE Zhibin WU

Done at _____, on _____
CITY, STATE DATE Hong CHENG

Done at _____, on _____
CITY, STATE DATE Sudhir Kumar BAGHEL

Done at _____, on _____
CITY, STATE DATE Shailesh PATIL

Done at _____, on _____
CITY, STATE DATE Kapil GULATI

Done at SAN JOSE, CA, on 12/23/19
CITY, STATE DATE Arjun BHARADWAJ

Done at _____, on _____
CITY, STATE DATE Tien Viet NGUYEN

Done at _____, on _____
CITY, STATE DATE Shuanshuan WU

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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
CITY, STATE DATE Zhibin WU

Done at _____, on _____
CITY, STATE DATE Hong CHENG

Done at _____, on _____
CITY, STATE DATE Sudhir Kumar BAGHEL

Done at SAN DIEGO, CA, on 1/7/20
CITY, STATE DATE SLP
Shailesh PATIL

Done at _____, on _____
CITY, STATE DATE Kapil GULATI

Done at _____, on _____
CITY, STATE DATE Arjun BHARADWAJ

Done at _____, on _____
CITY, STATE DATE Tien Viet NGUYEN

Done at San Diego, CA, on 12/10/2019
CITY, STATE DATE [Signature]
Shuanshuan WU